

AON7403 30V P-Channel MOSFET

General Description

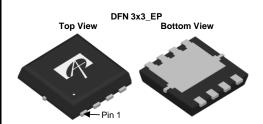
The AON7403 uses advanced trench technology to provide excellent $R_{\text{DS}(\text{ON})},$ and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications.

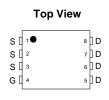
Product Summary

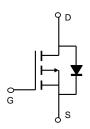
 $\begin{array}{lll} V_{DS} & -30V \\ I_{D} \; (at \; V_{GS} \!\!=\!\! -10V) & -29A \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -10V) & < 18 m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -5V) & < 36 m\Omega \end{array}$

100% UIS Tested









Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	-30	V	
Gate-Source Voltage		V_{GS}	±25	V	
Continuous Drain	T _C =25°C		-29		
Current	T _C =100°C	'D	-18	A	
Pulsed Drain Current ^C		I _{DM}	-80		
Continuous Drain Current	T _A =25°C		-11	A	
	T _A =70°C	IDSM	-8.5	A	
Avalanche Current ^C		I _{AR}	24	A	
Repetitive avalanche energy L=0.1mH ^C		E _{AR}	29	mJ	
	T _C =25°C	В	25	W	
Power Dissipation ^B	T _C =100°C	P _D	10	VV	
Power Dissipation ^A	T _A =25°C	В	4.1	W	
	T _A =70°C	P _{DSM}	2.6	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics							
Parameter	Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{ hetaJA}$	22	30	°C/W		
Maximum Junction-to-Ambient AD	Steady-State	$\kappa_{\theta JA}$	47	60	°C/W		
Maximum Junction-to-Lead Steady-		$R_{\theta JC}$	4.2	5	°C/W		

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units		
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$		-30			V		
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =-30V, V_{GS} =0V				-1	μА		
			T _J =55°C			-5			
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±25V				100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$		-1.7	-2.2	-3	V		
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V		-80			Α		
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-8A			14	18	mΩ		
			T _J =125°C		20	25			
		V _{GS} =-5V, I _D =-5A			26	36	$m\Omega$		
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-8A			20		S		
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.7	-1	V			
Is	Maximum Body-Diode Continuous Curr			-22	Α				
DYNAMIC	PARAMETERS		•						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			1130	1400	pF		
C _{oss}	Output Capacitance				240		pF		
C _{rss}	Reverse Transfer Capacitance				155		pF		
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			5.8	8	Ω		
SWITCHI	NG PARAMETERS								
Q _q (10V)	Total Gate Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-8A			18	24	nC		
Q_{gs}	Gate Source Charge				5.5		nC		
Q_{gd}	Gate Drain Charge				3.3		nC		
t _{D(on)}	Turn-On DelayTime				8.7		ns		
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.8 Ω , R_{GEN} =3 Ω			8.5		ns		
t _{D(off)}	Turn-Off DelayTime				18		ns		
t _f	Turn-Off Fall Time				7		ns		
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=500A/μs			12	16	ns		
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-8A, dI/dt=500A/μs			26		nC		
A The value of P is macoured with the device mounted on tip? EP 4 heard with 207 Copper in a ctill air equirement with T =25° C. The									

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R $_{0.JA}$ t \leq 10s value and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 150° C may be used if the PCB allows it.

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B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C. Ratings are based on low frequency and duty cycles to keep initial $T_J = 25^{\circ}$ C.

D. The R_{0JA} is the sum of the thermal impedence from junction to case R_{0JC} and case to ambient.

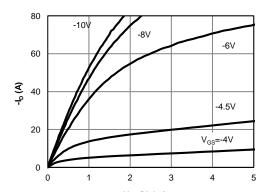
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

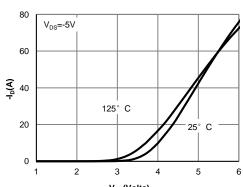
G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

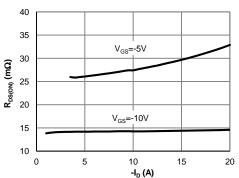
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



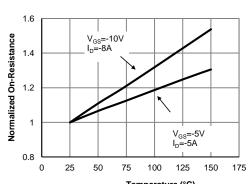
-V_{DS} (Volts) Fig 1: On-Region Characteristics (Note E)



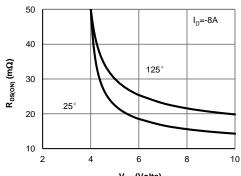
-V_{GS}(Volts)
Figure 2: Transfer Characteristics (Note E)



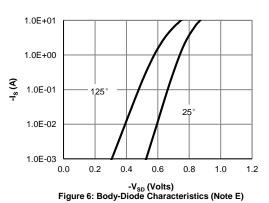
-I_D (A)
Figure 3: On-Resistance vs. Drain Current and Gate
Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)

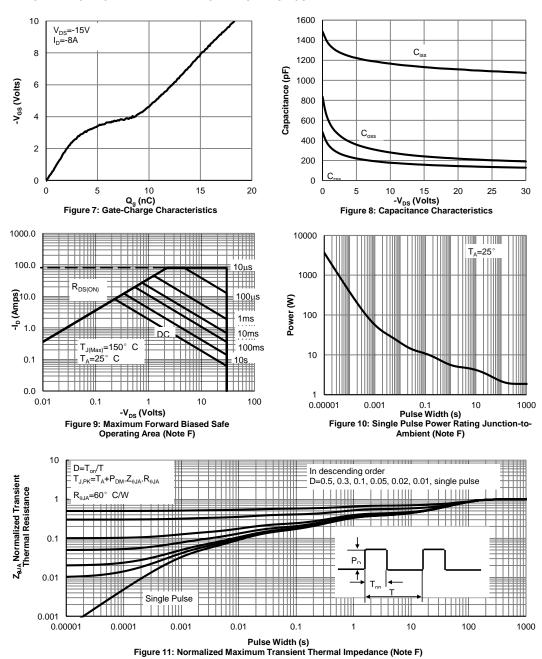


-V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage
(Note E)

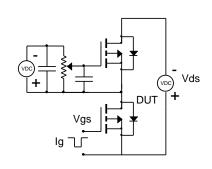


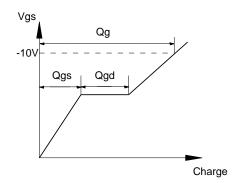
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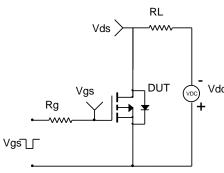


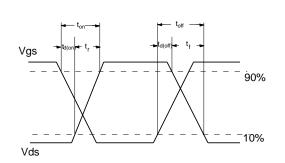
Gate Charge Test Circuit & Waveform



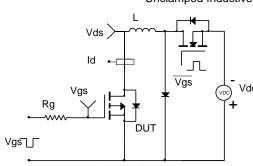


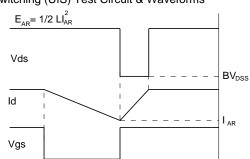
Resistive Switching Test Circuit & Waveforms



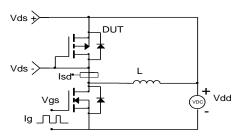


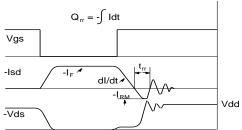
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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